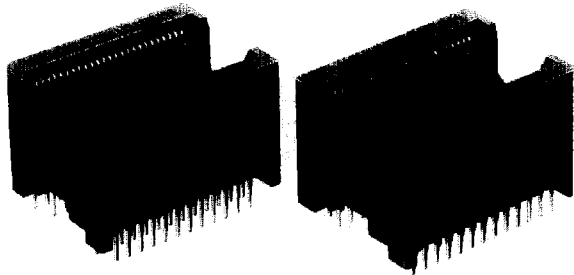


IC 268 SERIES SOJ



FEATURES

- Sockets for inserting 0.8mm pitch SOJ packages in dead-bug orientation.
- Unique contact design ensures outstanding contact reliability.

SPECIFICATIONS

PERFORMANCE

Insulation Resistance	1,000M Ω min. at 500VDC
Dielectric Withstanding Voltage	500VAC rms for 1 minute
Contact Resistance	30m Ω max. at 10mA
Operating Temperature Range	-55 $^{\circ}$ C to +170 $^{\circ}$ C

MATERIAL AND FINISH

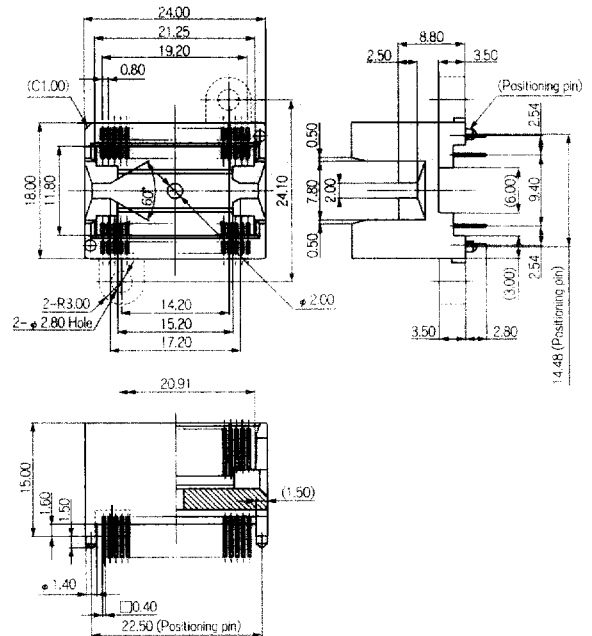
Housing	PEI (glass-filled)
Contacts	Copper alloy, gold plating over nickel (contacts), gold or solder plating over nickel (terminals)

ORDERING CODE

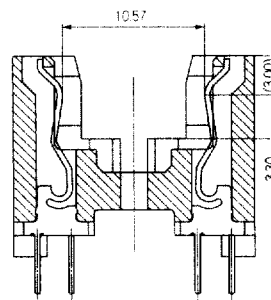
IC268—5004—BFMF—P

	IC268 series
	Number of leads
	IC package width 4 = 0.4 inches
	Type of contact plating B = Gold
	Type of terminal plating S = Solder F = Gold
	Flange option MF = With Unmarked = Without
	Positioning pin option P = With Unmarked = Without

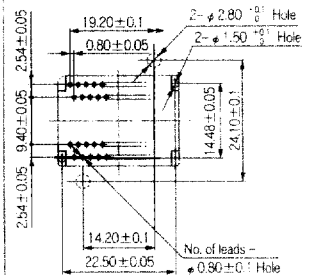
●Outline Dimensions



●Detail of Contact



●Recommended PC Board Patterns (TOP VIEW)



●Applicable IC Dimensions

